FIG.1

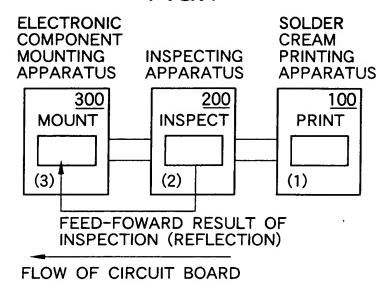
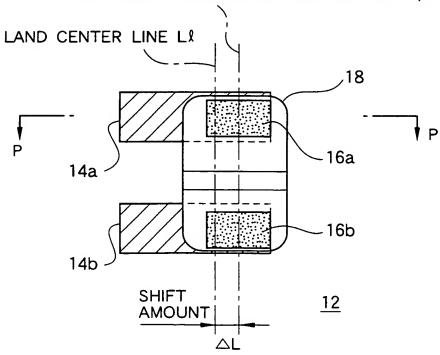
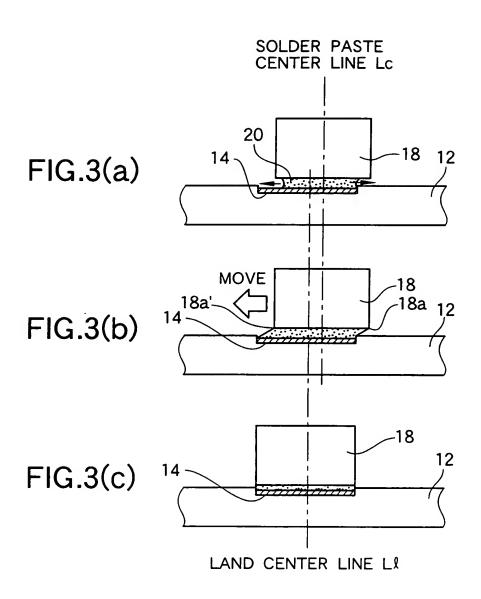
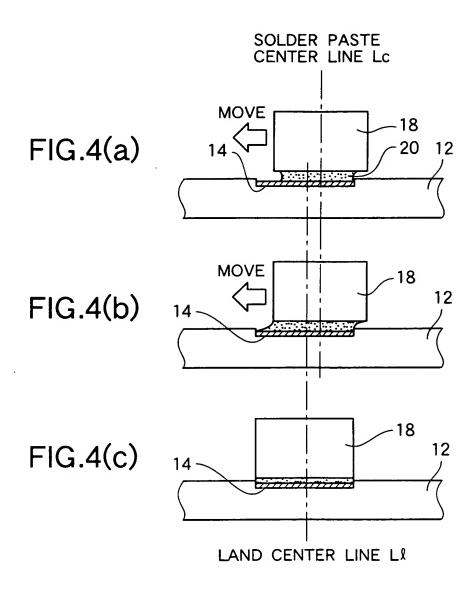


FIG.2

SOLDER PASTE CENTER LINE Lc ELECTRONIC COMPONENT CENTER LINE Lp







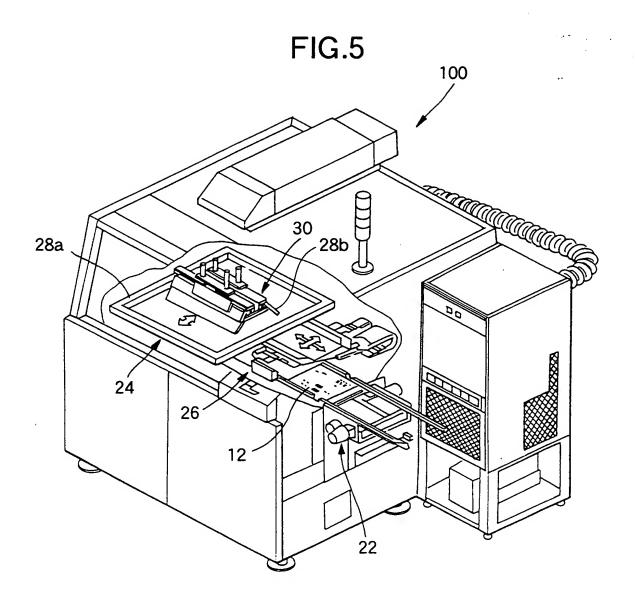
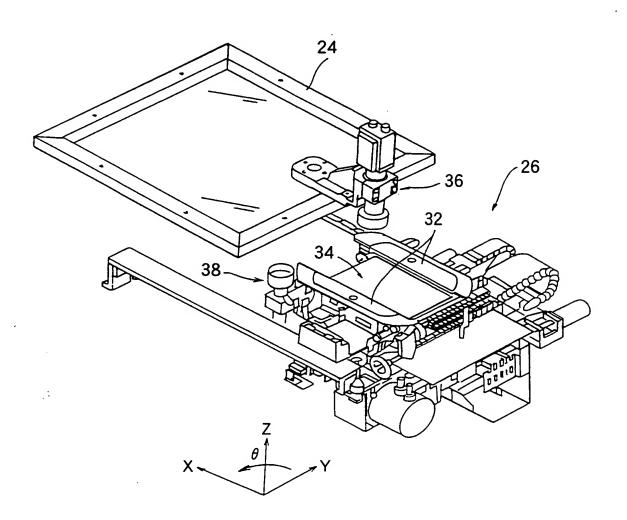
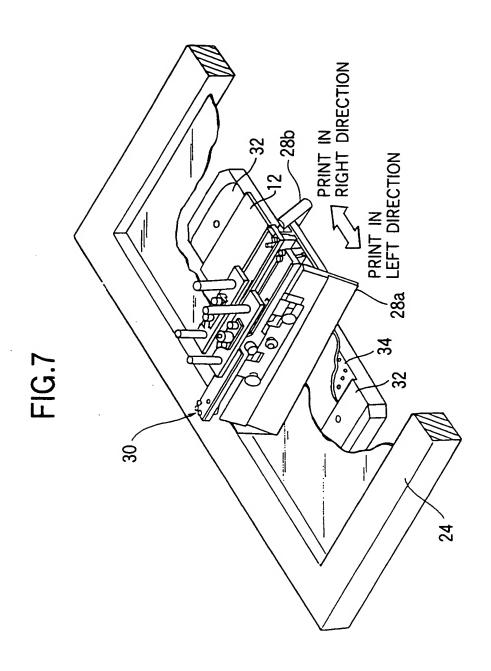
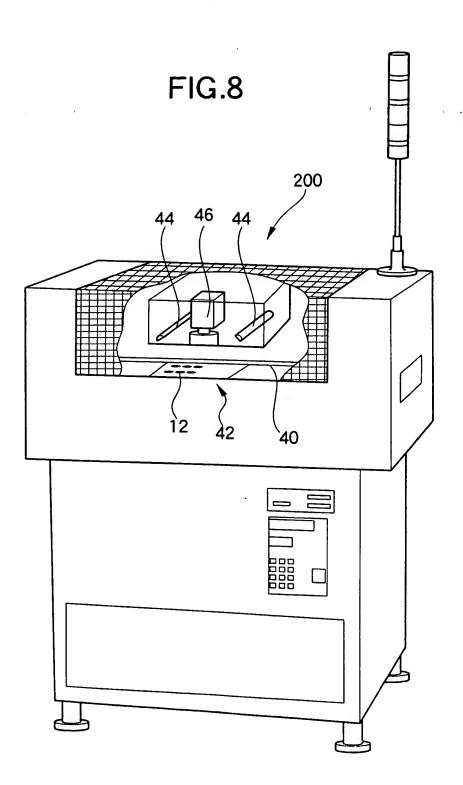
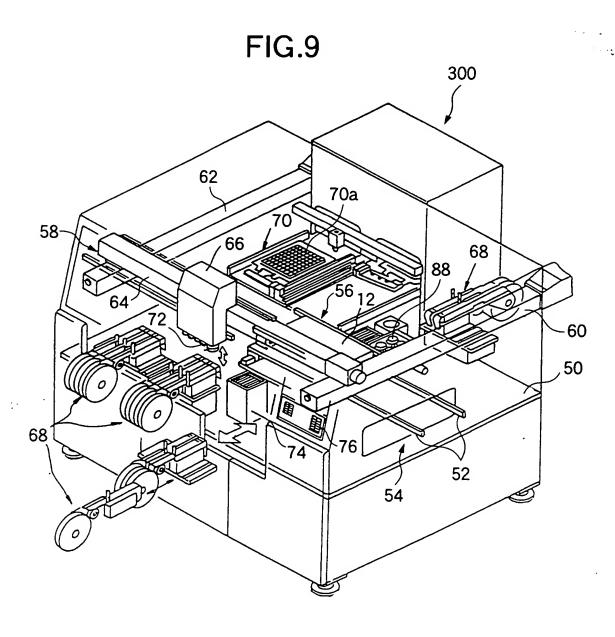


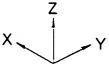
FIG.6











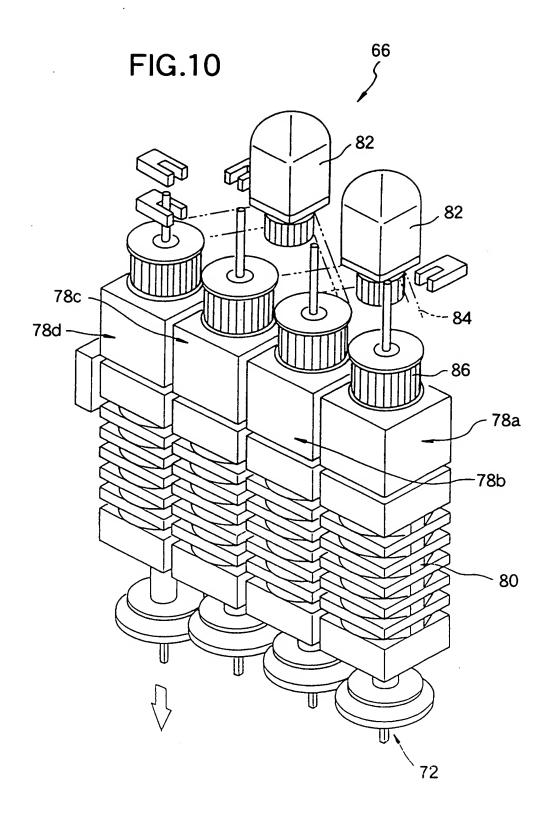


FIG.11

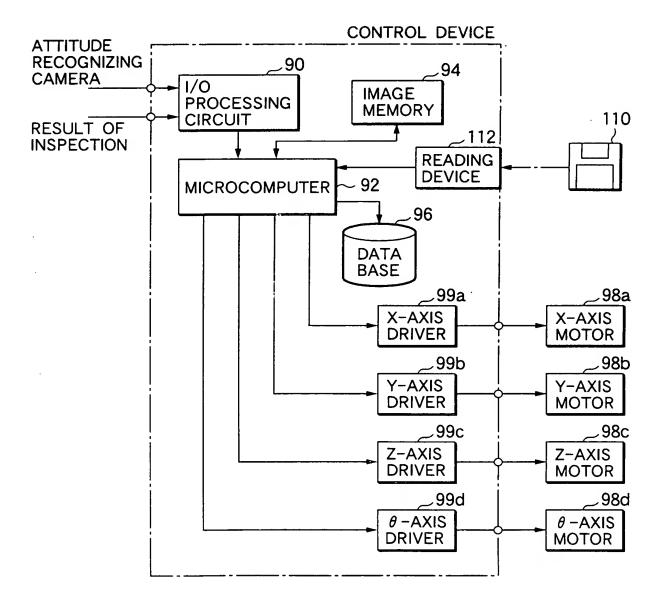


FIG.12

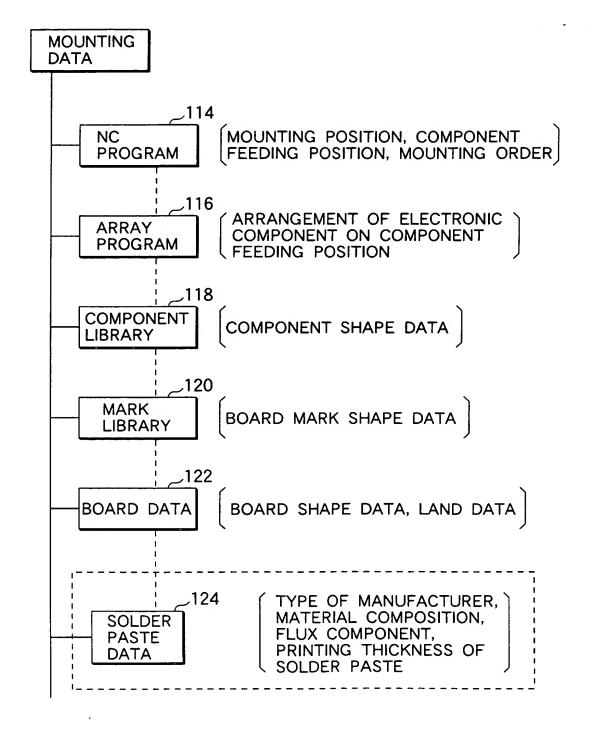


FIG.13

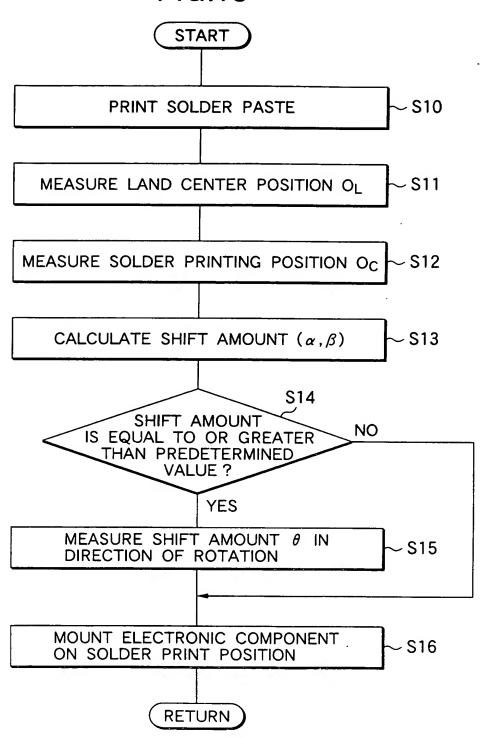


FIG.14

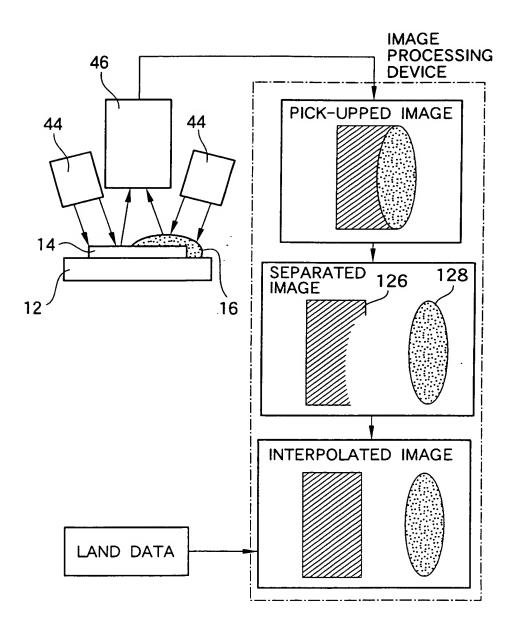
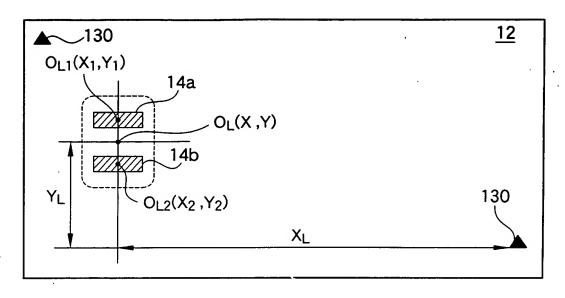
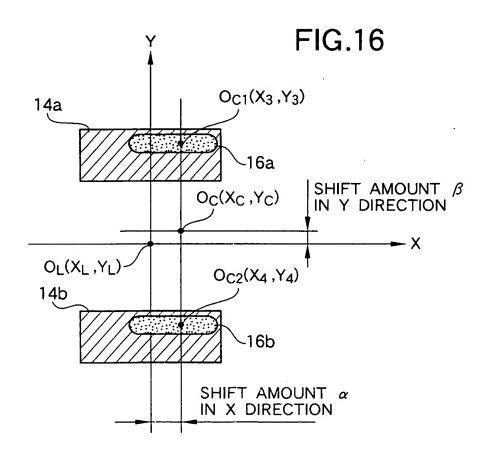
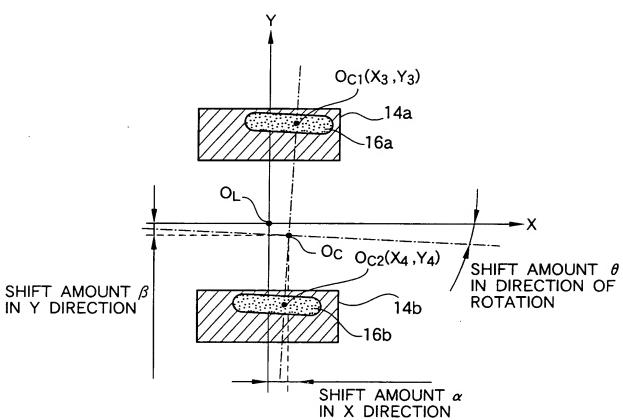


FIG.15









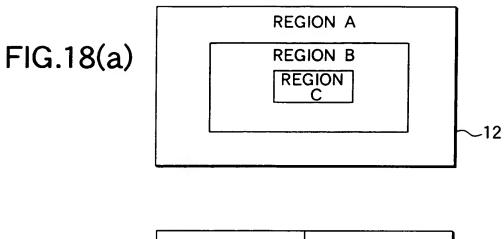


FIG.18(b)

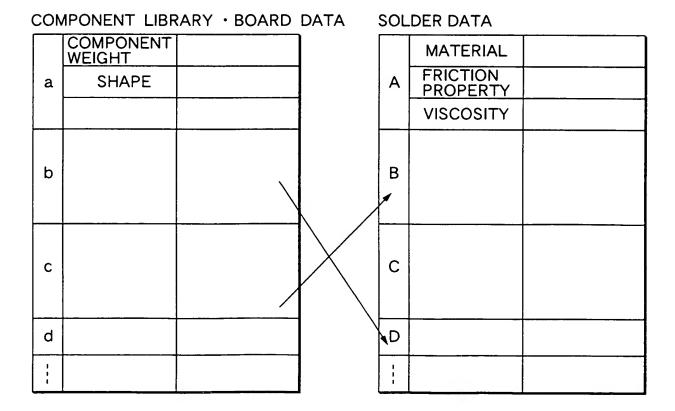
REGION A

REGION B

12

REGION D

FIG.19



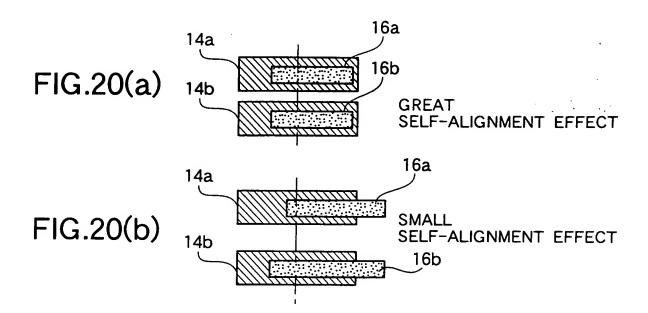
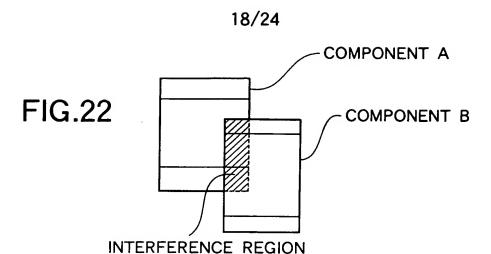


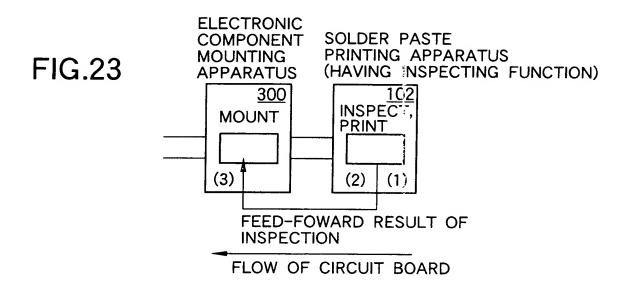
FIG.21

RETURN

START RECOGNIZE LAND **S20** POSITION AND SHAPE RECOGNIZE SOLDER PRINT POSITION AND **S21** SHAPE **S22** SELF-ALIGNMENT NO RATIO IS HIGH? YES **S23 S24** MOUNT ELECTRONIC MOUNT ELECTRONIC COMPONENT IN SOLDER COMPONENT IN LAND PRINT POSITION

POSITION





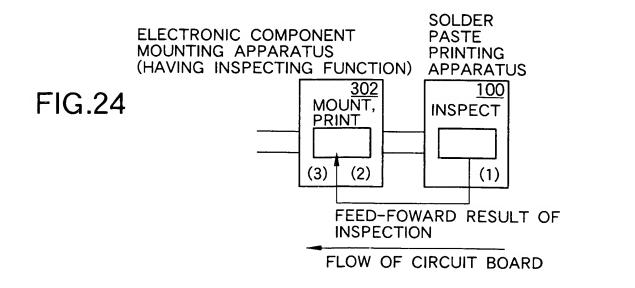
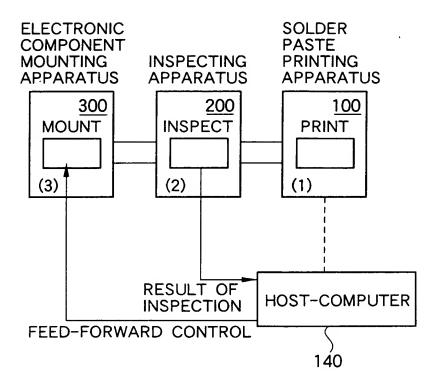


FIG.25



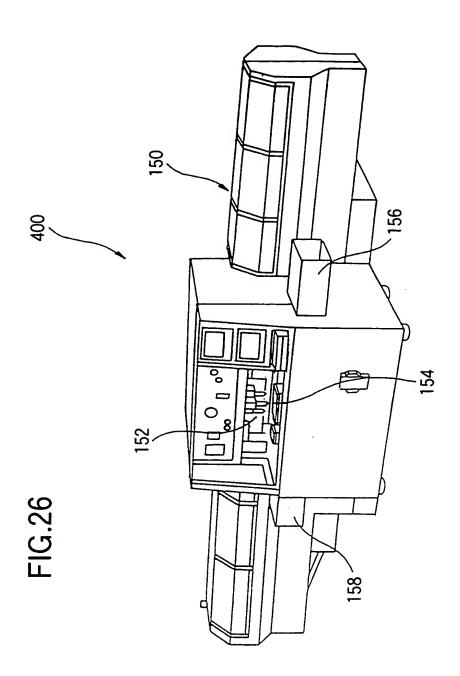


FIG.27

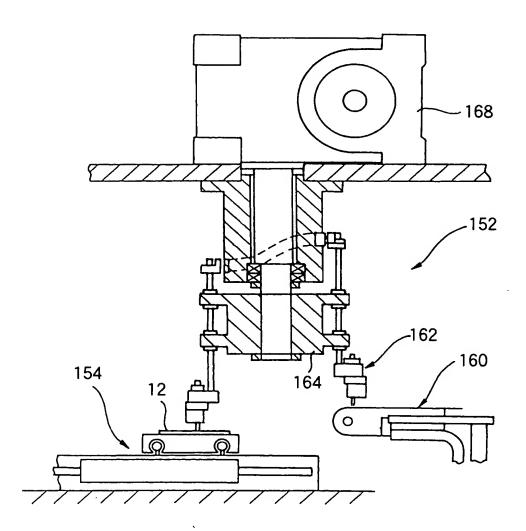


FIG.28(a)

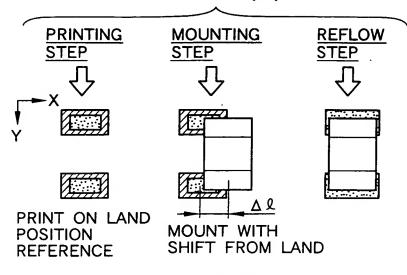


FIG.28(b)

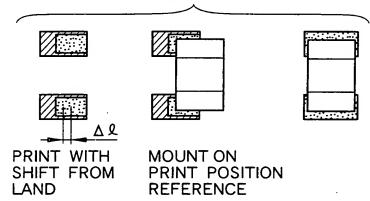


FIG.28(c)

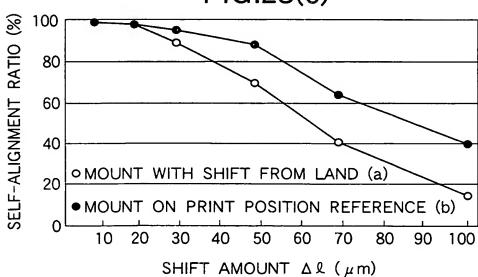


FIG.29

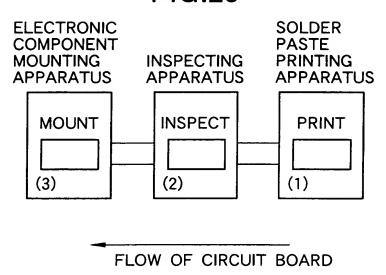


FIG.30(a)

FIG.30(b)

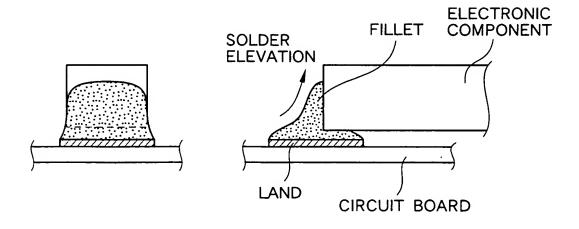


FIG.31(a)

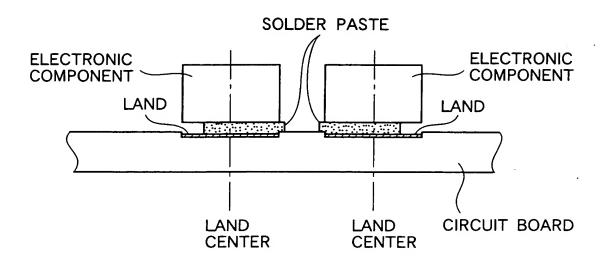


FIG.31(b)

